

NEWS

Industry Cooperation Publish Date : 2024-09-10

Tech Giants Phison and Wistron Invest NT\$2.3 Billion in Academic-Industrial Co-Creation, Donating Research Buildings to Jointly Nurture Innovation Talent



From left to right: Khein-Seng Pua, CEO of Phison Electronics; Chi-Hung Lin, President of NYCU; and Jeff Lin, President and CEO of Wistron Corporation.

Translated by Chance Lai

National Yang Ming Chiao Tung University (NYCU) has signed a landmark academic-industrial cooperation agreement with Phison Electronics Corporation and Wistron Corporation. The two tech giants, both leaders in their respective industries, will invest NT\$1.35 billion and NT\$954 million to construct the “Phison Building” and “Wistron Building” on NYCU’s Tainan campus. These state-of-the-art facilities will be donated to NYCU as part of their joint effort to foster innovation and talent development.



3D Rendering of Phison Building and Wistron Building

Corporate Contributions to Establish a Mutual Beneficial Mechanism for Academic-Industrial Co-Creation

NYCU’s Tainan campus, located in the Shalun Green Energy Science City—a government-designated hub for the 5+2 innovative industries—has been a pioneer in green technology research and education since the establishment of the Tainan Branch in 2009. The “Chimei Building” housed the College of Photonics, marking NYCU as the first academic and research institution in Shalun. Later, the College of Intelligent Science and Green Energy was founded, bolstering the academic-industrial research ecosystem in southern Taiwan. Furthermore, in June 2023, the Wistron-NYCU Joint Innovation Center for Intelligent and Green Energy Industries was inaugurated at the Guiren campus in Tainan, creating a hub for academic-industrial co-creation in these emerging fields. The Tainan Branch has long been a key player in research and talent development, becoming a critical partner for local industry.

NYCU President Chi-Hung Lin expressed deep gratitude for the generous support from Phison and Wistron. He emphasized that this collaboration will establish a mutually beneficial mechanism for academic-industrial co-creation. By bringing together industry engineers with practical experience and university faculty with cutting-edge research capabilities, this partnership will enhance academic-industrial collaboration, drive Taiwan’s technological advancement, and cultivate talent with academic and practical expertise. This, in turn, will contribute significantly to industry upgrades and societal progress.

NYCU Vice President and Tainan Campus Director Yung-Fu Chen highlighted that the Phison Building will have six above-ground floors and two basement levels. The Wistron Building will feature five above-ground floors and one basement level. Both buildings are set to break ground in October this year, with Phison and Wistron handling design and construction. NYCU will actively participate in key construction meetings, and the project is expected to be completed within three years through a joint effort from all parties.

Industry’s Strong Commitment to University Education and Technological Innovation

This collaboration showcases Phison and Wistron’s commitment to university education and technological innovation. Phison, a global leader in NAND storage applications and artificial intelligence (AI), is renowned for developing advanced NAND controller chips and storage solutions—technologies essential to AI advancements. Their involvement will provide NYCU with access to cutting-edge technologies and research opportunities.

Wistron, specializing in information and communication technology (ICT) products, focuses on AI, automotive, and Industry 4.0 automation. Through this partnership, Phison and Wistron will drive the innovation and application of AI technologies and smart manufacturing, cultivating more tech-savvy talent and advancing Taiwan’s high-tech industry. This collaboration enhances NYCU’s research and educational resources and significantly contributes to the entire industry ecosystem.

The donation ceremony and academic-industrial cooperation agreement signing on September 5 solidified the shared vision and support between industry, academia, and government. NYCU will work closely with Phison and Wistron to create further technological and educational breakthroughs, fostering a prosperous relationship between academia, local industries, and the broader community.

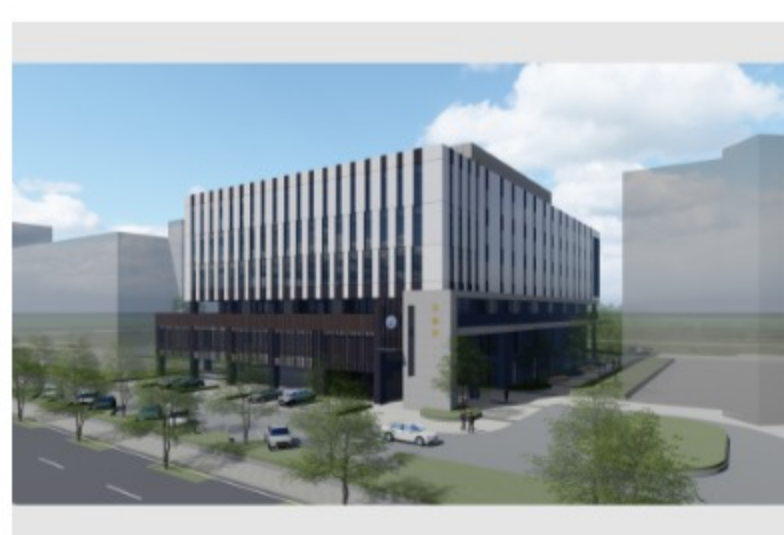


The Signing Ceremony Between NYCU, Phison Electronics, and Wistron Corporation.

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3D Rendering of the Phison Building



3D Rendering of the Wistron Building

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